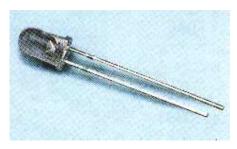


DATASHEET

Lamp 7383/Y7C3-ARUB/X/MS



Features

- Popular T-1 3/4 round package.
- 'High efficiency.
- 'Available on tape and reel.
- Reliable and robust.
- 'UV resistant epoxy
- The product itself will remain within RoHS compliant version.
- 'Compliance with EU REACH
- *Compliance Halogen free. (Br <900 ppm, Cl<900 ppm, Br+Cl <1500 ppm).

Descriptions

- The series is specially designed for applications requiring higher brightness.
- The LED lamps are available with different colors, intensities, epoxy colors, etc.

Applications

- Color Graphic Signs
- 'Message boards
- 'Variable message signs (VMS)
- 'Commercial outdoor advertising



Device Selection Guide

LED Part No.	Chip Materials	Emitted Color	Resin Color	Stopper
7383/Y7C3-ARUB/MS	AlGalnP	Brilliant Yellow	Water clear	No
7383/Y7C3-ARUB/P/MS				Yes

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit		
Reverse Voltage	V _R	5	V		
Forward Current	I _F	50	mA		
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	160	mA		
Power Dissipation	Pd	115	mW		
Operating Temperature	T _{opr}	-40 ~ +85	$^{\circ}\! \mathbb{C}$		
Storage Temperature	Tstg	-40 ~ +100	$^{\circ}$ C		
Soldering Temperature	T _{sol}	260 °C for 5 sec.			
EVERLIGHT					



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	4500	7150	11250	mcd	I _F =20mA
Viewing Angle	2θ _{1/2}		30		deg	I _F =20mA
Peak Wavelength	λр		591		nm	I _F =20mA
Dominant Wavelength	λd	586	589	594	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		15		nm	I _F =20mA
Forward Voltage	V _F	1.8	2.0	2.6	V	I _F =20mA
Reverse Current	I _R			10	μA	V _R =5V

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
R	4500	5650		I _F =20mA
S	5650	7150	mcd	
Т	7150	9000		
U	9000	11250		
e: erance of Luminous Intensity: ±10%	9000	11250		
Bin Range of Dominant Way	volonath			

Note:

Tolerance of Luminous Intensity: ±10%

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
1	586	590		I -00m A
2	590	594	nm	I _F =20mA

Note:

Tolerance of Dominant Wavelength: ±1nm

Bin Range of Forward Voltage

Bin Code	Min.	Max.	Unit	Condition
1	1.8	2.0	V	I _F =20mA
2	2.0	2.2		
3	2.2	2.4		
4	2.4	2.6		

Note:

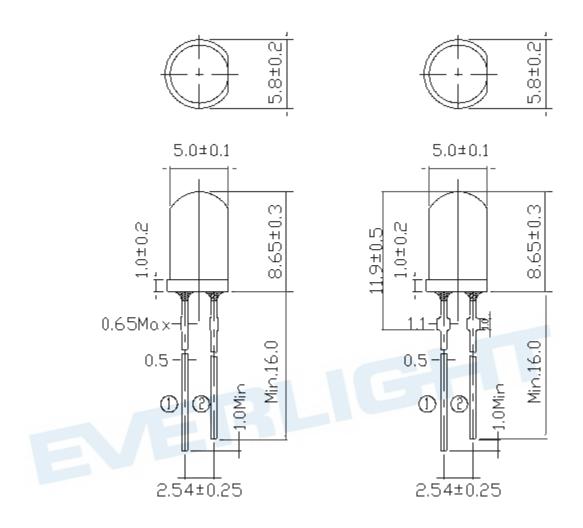
Tolerance of Forward Voltage: ±0.1V

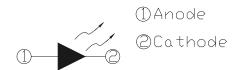


Typical Electro-Optical Characteristics Curves Relative Intensity vs. Wavelength (Ta=25°C) Directivity (Ta=25°C) 1.0 0° 10° 50° 30° Relative Intensity (a.u.) 0.8 Radiation Angle 40° 0.6 1.0 0.9 50° 0.4 0.8 60° 70° 0.7 80° 90° 0. 2 0.0 L 450 0, 3 0.1 0.4 0.6 0.5 500 550 600 650 700 Wavelength (nm) Relative Intensity (a.u.) Forward Current vs. Forward Voltage (Ta=25°C) Relative Intensity vs. Forward Current (Ta=25°C) 2.5 50 2.0 40 Relative Intensity(a.u.) Forward Current (mA) 1.5 30 1.0 20 0.5 10 0.0 0 L 1.0 10 50 1.5 2.0 2.5 3.0 Forward Voltage (V) Forward Current (mA) Relative Intensity vs. Ambient Temp. Forward Current vs. Ambient Temp. 2.0 60 50 Relative Intensity(a.u.) Forward Current (mA) 1.5 40 1.0 30 20 0.5 10 35 40 45 50 55 60 100 Ambient Temperature Ta(°C) Ambient Temperature Ta(°C)



Package Dimension





Note:

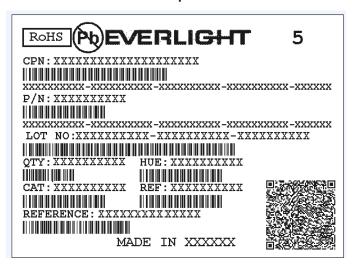
Other dimensions are in millimeters, tolerance is 0.25mm except being specified.

Protruded resin under flange is 1.5mm Max LED.

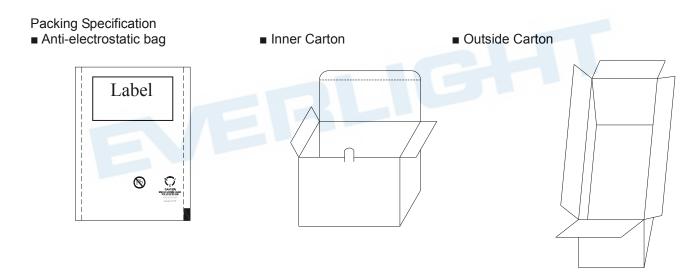


Moisture Resistant Packing Materials

Label Explanation



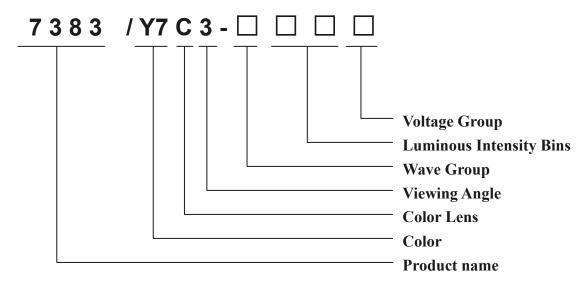
- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Ranks of Luminous Intensity
- · HUE: Rank of Dominant Wavelength
- · REF: Ranks of Forward Voltage
- · LOT No: Lot Number



- Packing Quantity
- 1. Min 200pcs to Max 500 PCS/1 Bag, 5 Bags/1 Inner Carton.
- 2. 10 Inner Cartons/1 Outside Carton



Production Designation



Notes

1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

2. Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

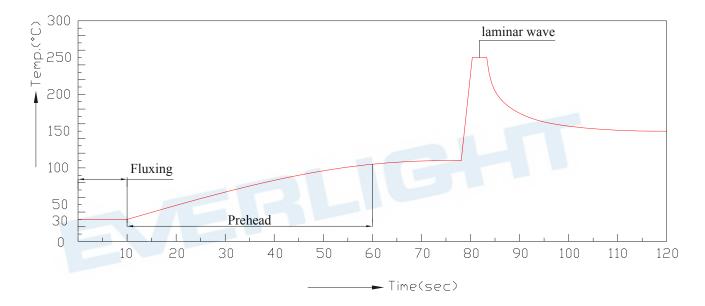


3. Soldering

- Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
- Recommended soldering conditions:

Hand Soldering		DIP Soldering		
Temp. at tip of iron	300°C Max. (30W	Preheat temp.	100°C Max. (60 sec	
Temp. at up of from	Max.)		Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max	
Distance	3mm Min.(From	Distance	3mm Min. (From	
	solder joint to epoxy		solder joint to epoxy	
	bulb)		bulb)	

Recommended soldering profile



- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.



4. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED.

5. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

6. ESD (Electrostatic Discharge)

■ The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.

When handling the products, the following measures against electrostatic discharge are strongly recommended:

Eliminating the charge

Grounded wrist strap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

- Proper grounding is required for all devices, equipment, and machinery used in product assembly.
 Surge protection should be considered when designing of commercial products.
- If tools or equipment contain insulating materials such as glass or plastic, the following measures against electrostatic discharge are strongly recommended:

Dissipating static charge with conductive materials

Preventing charge generation with moisture

Neutralizing the charge with ionizers.

7. Directions for use

■ The LEDs should be operated with forward bias. The driving circuit must be designed so that the LEDs are not subjected to forward or reverse voltage while it is off. If reverse voltage is continuously applied to the LEDs, it may cause migration resulting in LED damage.



8. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation.

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DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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